

N-Channel MOSFET

Applications:

- Adaptor
- Charger
- .SMPS

Features:

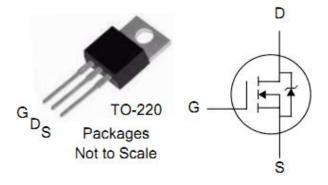
- RoHS Compliant
- Low ON Resistance
- Low Gate Charge
- Peak Current vs Pulse Width Curve
- Inductive Switching Curves

Ordering Information

PART NUMBER		PACKAGE	BRAND		
	FTP04N04ND	TO-220	IPS		



V_{DSS}	$R_{DS(ON)}(Typ.)$	I _D (Silicon
40V	$2.5 m\Omega$	140A



Absolute Maximum Ratings $T_C=25^{\circ}C$ unless otherwise specified

Symbol	Parameter	FTP04N04ND	Units
V _{DSS}	Drain-to-Source Voltage	40	V
I _D	Continuous Drain Current	140	А
	Continuous Drain Current T _C =100 °C	88	А
I _{DM}	Pulsed Drain Current (NOTE *1)	560	Α
V _{GS}	Gate-to-Source Voltage	±20	V
E _{AS}	Single Pulse Avalanche Energy(NOTE *2)	656	mJ
T _L	Maximum Temperature for Soldering	300	
T _J and T _{STG}	Operating Junction and Storage Temperature Range	150,-55 to150	${\mathbb C}$

OFF Characteristics T_C=25 °C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BV _{DSS}	Drain-to-Source Breakdown Voltage	40			V	V_{GS} =0V, I_D =250 μ A
				1		V_{DS} =40V, V_{GS} =0V
1	Drain to Source Lookage Current			ı	μА	T _C =25°C
I _{DSS}	Drain-to-Source Leakage Current			500		V_{DS} =32V, V_{GS} =0V
				500		$T_C=125^{\circ}C$
1	Gate-to-Source Forward Leakage			+100	nΛ	V _{GS} =+20V
I _{GSS}	Gate-to-Source Reverse Leakage			-100	nA	V _{GS} = -20V

ON Characteristics $T_C=25^{\circ}C$ unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
R _{DS(ON)}	StaticDrain-to-Source On-Resistance		2.5	3.2	mΩ	V_{GS} =10V, I_D =30A
$V_{GS(TH)}$	Gate Threshold Voltage	2		4	V	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$
Pulse width ≤300μs; duty cycle≤ 2%						

Dynamic Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
R _g	Gate Resistance		0.9		Ω	$f=1MHz$, $V_{GS}=0V$, $V_{DS}=0V$
C _{iss}	Input Capacitance		5913		pF	V_{GS} = 0V, V_{DS} = 20V f =1.0MHz
C _{oss}	Output Capacitance		680			
C_{rss}	Reverse Transfer Capacitance		601			
Q_g	Total Gate Charge		119			$I_D = 70A, V_{DD} = 32V$ $V_{GS} = 10V$
Q_{gs}	Gate-to-Source Charge		17		nC	
Q_{gd}	Gate-to-Drain ("Miller") Charge		35			

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
t _{d(ON)}	Turn-on Delay Time		28		ns	V_{DD} =20V, I_{D} =70A, V_{G} =10V R_{G} =6 Ω
t _{rise}	Rise Time		20			
t _{d(OFF)}	Turn-Off Delay Time		110			
t _{fall}	Fall Time		42			



Source-Drain Diode Characteristics Tc=25 ℃ unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
	Continuous Source Current			140	А	- T _C =25℃
I _S	(Body Diode)			140		
	Maximum Pulsed Current			560	А	
I _{SM}	(Body Diode)			360		
V_{SD}	Diode Forward Voltage			1.2	V	I_{SD} =30A, V_{GS} =0V
t _{rr}	Reverse Recovery Time		29		ns	I _F =20A
Q _{rr}	Reverse Recovery Charge		21		nC	di/dt=100A/us
Pulse width ≤300µs; duty cycle ≤ 2%						

Notes:

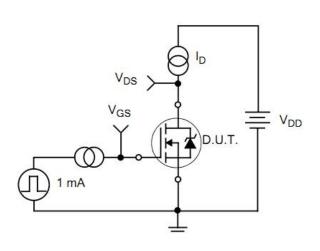
^{*1.} Repetitive rating; pulse width limited by maximum junction temperature.

^{*2.} L=0.5mH, V_{DD} =20V, Start T_J =25 $^{\circ}$ C



Test Circuits and Waveforms

Figure 14. Gate Charge Test Circuit



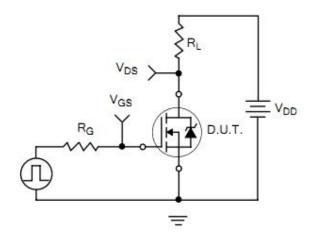
V_{DS} I_D Miller V

Figure 15. Gate Charge Waveforms

V_{GS(TH)}

Figure 16. Resistive Switching Test Circuit

Figure 17. Resistive Switching Waveforms



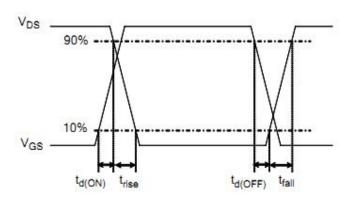






Figure 18. Diode Reverse Recovery Test Circuit

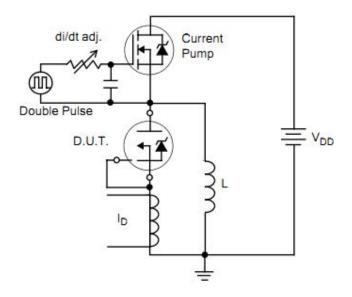


Figure 19. Diode Reverse Recovery Waveform

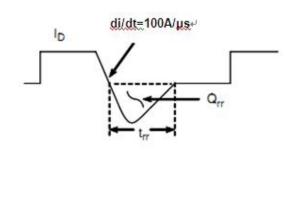
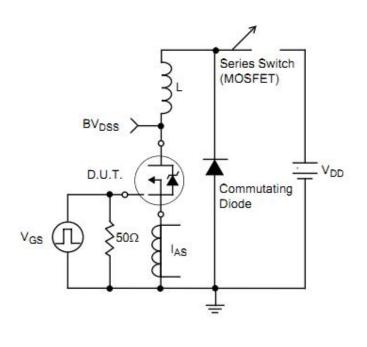
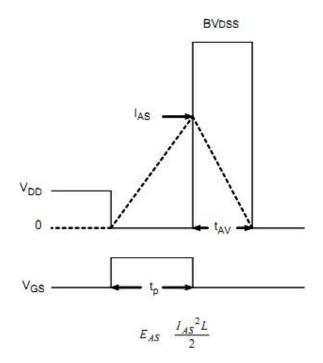


Figure 20. Unclamped Inductive Switching Test Circuit

Figure21.Unclamped Inductive Switching Waveform







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